

编辑计划 Editorial Calendar

刊期 Issues	封面故事 Cover Story	技术特写 Tech Features	特别报道 Special Supplements	展会派发 Bonus Distribution
Feb/Mar Issue date: Feb 22 Mat close: Feb 15 Ad close: Feb 08 Ed close: Jan 22	<ul style="list-style-type: none"> 焊接 Soldering 	<ul style="list-style-type: none"> 检查与测试 Inspection & Test 返修 Rework & Repair 	<ul style="list-style-type: none"> SMT 组装技术 SMT Assembly Technology 	<ul style="list-style-type: none"> Semicon China 上海/ Shanghai Mar 14-16 慕尼黑上海电子生产设备展 Productronica/ electronica China 上海/ Shanghai Mar 14-16 SbSTC 重庆/ Chongqing Mar SbSTC 深圳/ Shenzhen Mar
Apr/May Issue dates: Apr 14 Mat close: Apr 07 Ad close: Mar 31 Ed close: Mar 14	<ul style="list-style-type: none"> 自动化 Automation 	<ul style="list-style-type: none"> 锡膏和助焊剂 Solder Pastes & Fluxes 热管理 Thermal Management 	<ul style="list-style-type: none"> 可靠性 Reliability 	<ul style="list-style-type: none"> 中国国际电子生产设备暨反微电子工业展 Nepcon China/ EMT China 上海/ Shanghai Apr 25-27 SbSTC 苏州/ Suzhou Jun 广州国际照明展览会 (光亚展) Guangdong Int'l Lighting Fair 广州/ Guangzhou Jun
Jun/Jul Issue dates: Jun 15 Mat close: Jun 08 Ad close: Jun 01 Ed close: May 15	<ul style="list-style-type: none"> 智能制造 Intelligent Manufacturing 	<ul style="list-style-type: none"> 底部填胶与点胶 Underfill & Dispensing 清洗 Cleaning 	<ul style="list-style-type: none"> 物联网应用 IoT Applications 	<ul style="list-style-type: none"> SbSTC 成都/ Chengdu Jul/S SbSTC 东莞/ Dongguan Jul 中国电子设备产业博览会 EEIE 深圳/ Shenzhen Jul
Aug/Sep Issue dates: Aug 18 Mat close: Aug 11 Ad close: Aug 04 Ed close: July 19	<ul style="list-style-type: none"> 检查与测试 Inspection & Test 	<ul style="list-style-type: none"> 表面涂敷 Conformal Coating 锡膏印刷与检查 Solder Paste Printing & Inspection 	<ul style="list-style-type: none"> 热管理 Thermal Management 	<ul style="list-style-type: none"> 华南国际电子生产设备暨反微电子工业展 Nepcon South China 深圳/ Shenzhen Aug 29-31 LED展 LED China 上海/ Shanghai Sep 洁净室 CleanRooms China 上海/ Shanghai Sep SbSTC 南昌/ Nanchang Sep
Oct/Nov Issue dates: Oct 19 Mat close: Oct 12 Ad close: Oct 05 Ed close: Sep 19	<ul style="list-style-type: none"> 返修 Rework & Repair 	<ul style="list-style-type: none"> 焊接 Soldering 清洗 Cleaning 	<ul style="list-style-type: none"> 供应链 Supply Chain 	<ul style="list-style-type: none"> SbSTC 杭州/ Hangzhou Oct 中国高科技展 China Hi-Tech 深圳/ Shenzhen Nov SbSTC 惠州/ Huizhou Nov
Dec/Jan Issue dates: Dec 01 Mat close: Nov 24 Ad close: Nov 17 Ed close: Nov 01	<ul style="list-style-type: none"> 锡膏和助焊剂 Solder Pastes & Fluxes 	<ul style="list-style-type: none"> 检查与测试 Inspection & Test 返修 Rework & Repair 	<ul style="list-style-type: none"> 无铅进展 Lead-Free Development 	<ul style="list-style-type: none"> 国际(IPCBF)印制板及组装交易会 International Printed Circuit Board & Assembly Fair 深圳/ Shenzhen Dec

• 更新的展会信息请访问: More up-to-date events information can be found in our website www.smtchinamag.com
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电子快讯编辑计划 eFocus Editorial Calendar

第一卷 Vol. One	主题 Theme
Jan 05	* 自动化 Automation
Feb 07	* 焊接 Soldering
Mar 07	* 清洗 Cleaning
Apr 07	* Nepcon 上海展产品预览 1 Nepcon Product Preview 1
May 05	* SMTChina 远见奖获奖名单 Vision Award Winners Announcement
Jun 07	* 锡膏印刷与检查 Paste Printing & Inspection
Jul 07	* 3D 打印 3D Printing
Aug 08	* Nepcon 华南展产品预览 1 Nepcon South China Product Preview 1
Sep 07	* 检查与测试 Test & Inspection
Oct 10	* 锡膏与助焊剂 Solder Pastes & Fluxes
Nov 07	* 表面涂敷 Conformal Coating
Dec 07	* 管理与管理工具 Management & Tools

第二卷 Vol. Two	主题 Theme
Jan 20	* SMT 组装 SMT Assembly
Feb 21	* 锡膏和助焊剂 Solder Pastes & Fluxes
Mar 21	* 底部填胶 Underfill
Apr 21	* Nepcon 上海展产品预览2 Nepcon Product Preview 2
May 18	* 检查与测试 Test & Inspection
Jun 21	* Nepcon 西部展产品预览 Nepcon West China Product Preview
Jul 21	* 返修 Rework
Aug 21	* Nepcon 华南展产品预览 2 Nepcon South China Product Preview 2
Sep 21	* 供应链 Supply Chain
Oct 24	* 焊接 Soldering
Nov 21	* 热管理 Thermal Management
Dec 20	* 可靠性 Reliability